# Wire Wound Magnetically Shielded SMD Power Inductor



**ASPI-8040S** 

RoHS/RoHS II compliant

8.0 x 8.0 x 4.2mm

Part Number ASPI-8040S- Inductance Code	Inductance	L Tolerance	DC Resistance (±30%)			Min. Self resonant frequency MHz	
Units	Units µH		Ω	Α	Α		
Symbol	L	N, M	DCR	Isat	Irms	SRF	
ASPI-8040S-121	120	M	0.334	1.05	0.95	3.5	
ASPI-8040S-151	150	M	0.410	1.10	0.85	3.5	
ASPI-8040S-221	220	M	0.599	0.85	0.80	3.5	
ASPI-8040S-331	330	M	0.889	0.68	0.64	2.8	

#### **Test Conditions:**

a. Ambient Temperature: 20± 15°C b. Relative Humidity: 65%±20% c. Air Pressure: 86KPa to 106KPa

Inductance (L): ZM2355 LCR meter or equivalent, 100kHz, 1V<sub>rms</sub>

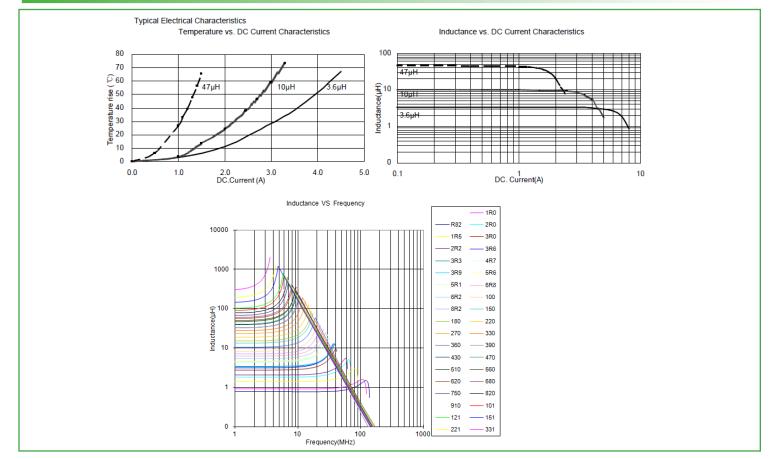
Direct Current Resistance (DCR): HIOKI 3540 or equivalent

Saturation Current (Isat): Saturation current meter Isat: Based on inductance change ( $\Delta$  L/Lo : $\Delta$  -30%)

Temperature rise current (Irms): Electric Power, Electric current meter, Thermometer

Irms: Based on temperature rise ( $\Delta$  T : 40 °C TYP.)

### ► ELECTRICAL CHARACTERISTICS CURVES





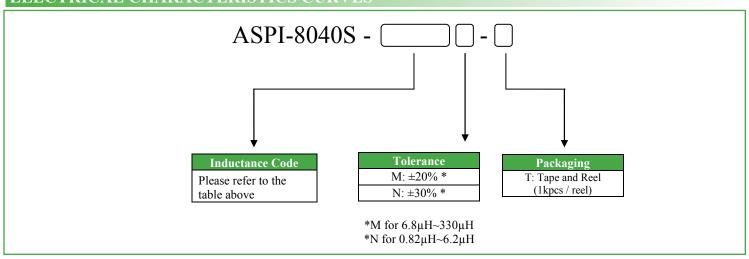
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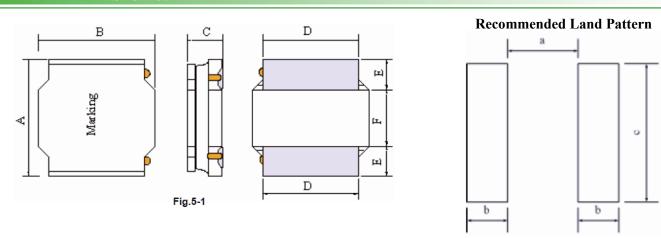








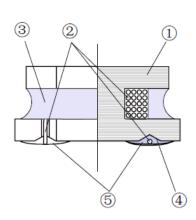
### **OUTLINE DIMENSIONS:**



A	В	C Max.	D	Е	F	а Тур.	b Тур.	с Тур.
8.0±0.3	8.0±0.3	4.2Max.	6.3±0.3	2.00±0.3	4.0±0.3	3.8Typ.	2.2Typ.	7.5Typ.

**Dimensions: mm** 

### **Materials**



No	Components	Material			
1	Ferrite Core	Ni-Zn Ferrite			
2	Wire	Polyurethane System enameled copper wire			
3	Magnetic Glue	Epoxy resin and magnetic powder			
4	Plating Electrodes	Plating: Ag/Ni/Sn			
5	Outer Electrodes	Top surface solder coating:Sn96.5%/Ag3.0%/Cu0.5%			



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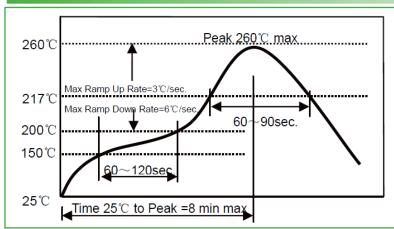
ASPI-8040S





8.0 x 8.0 x 4.2mm

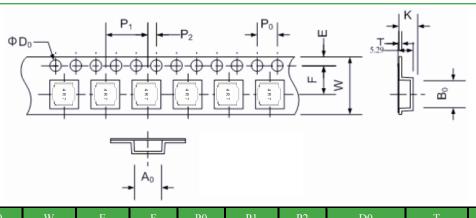
#### > REFLOW PROFILE



- Δ 1~2 °C/sec. Ramp
- Δ Pre-heating: 150~190°C/90±30 sec.
- $\Delta$  Time above 240°C: 20~40sec
- Δ Peak temperature: 260°C Max./5sec;
  Δ Solder paste: Sn/3.0Ag/0.5Cu
- Δ Max.2 times for Re-flowing

#### > TAPE & REEL:

## Packing T: 1,000pcs / reel



	AU	BU	W	E	Г	P0	PI	P2	D0	1	K
	8.35±0.1	8.35±0.1	16.0±0.3	1.75±0.1	7.5±0.1	4.0±0.1	12.0±0.1	2.0±0.1	1.5+0.1/-0.0	0.4±0.03	4.4±0.
						16.4+0.2/-0.0-					
2.3±0.2											

### **Storage Conditions**

- a. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- b. Recommended conditions:  $-10^{\circ}$ C  $\sim 40^{\circ}$ C, 70% RH (Max.)
- c. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- d. In case of storage over 6 months, solderability shall be checked before actual usage.

Dimension: mm

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